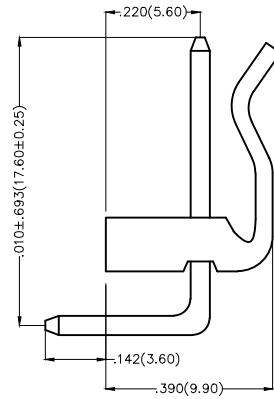
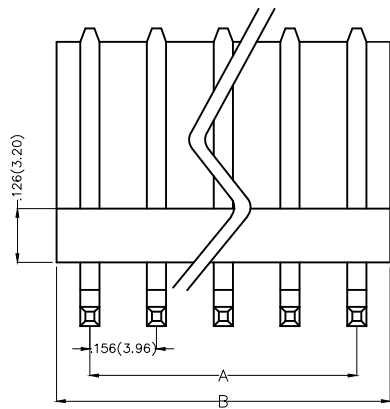


REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD
1	▲	Dimension $\phi.065(\phi1.65)$ Change to $\phi.071(1.80)$	20150919	CHERRY	FAN

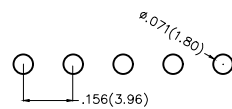
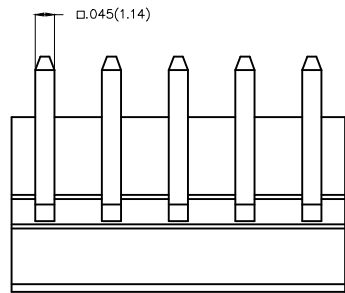


Electrical

Current Rating: 6A AC(rms)/DC
Voltage Rating: 250V AC(rms)/DC
Contact Resistance: 10 mΩ Max
Insulation Resistance: 1000 MΩ MIN
Withstanding Voltage: 1500V AC r.m.s
Temperature Range—Operating: -25°C~+85°C

Material and Plating

Housing: PA66(UL 94V-0)
Contact Pin: Brass
Plating: Tin Plated



Recommended P.C.Board Layout

Ordering Information

FWF 396 04 — S XX B 2 2 T B
1 2 3 4 5 6 7 8 9 10

1 <u>Category</u> FWF—Wafer	2 <u>Series Number</u> 396—Pitch3.96mm	3 <u>Distinction No.</u> 04	4 <u>Row Option</u> Single Row	5 <u>Circuits</u> XX	6 <u>Entry Angle</u> B—90° Angle
7 <u>Plating</u> 2—Tin Plated	8 <u>Material—Resin</u> 2—PA66	9 <u>Color—Resin</u> T—Transparent	10 <u>Packaging</u> B—PE Bag		

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 19/SEP/15	PART NO. FWF39604—SXXB22TB	ITEM NO. FWF39604	 Leader Of Industry	
	DESIGN UNITS Inch (metric)	X.±.012(0.30)	X.'±5'	CHECKED BY CHERRY	DATE 19/SEP/15	TITLE Wire to Board (Wafer) Pitch 3.96mm 90° Angle (DIP)		REV 1
SCALE 5:1	SIZE A4	X.XX±.006(0.15)	.XX'±1'	DRAWN BY JACOB	DATE 19/SEP/15	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

1 2 3 4 5 6 7 8

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD
1	△	Dimension $\phi.065(\phi1.65)$ Change to $\phi.071(1.80)$	20150919	CHERRY	FAN

A

A

B

B

C

C

D

D

E



E

F

F

Material and Plating : Housing PA66 UL94V-0 , Tin Plated.

Circuits (n)	Part No.	Dimensions(in/mm)	
		A	B
2	FWF39604-S02B22TB	.156(3.96)	.311(7.92)
3	FWF39604-S03B22TB	.311(7.92)	.468(11.88)
4	FWF39604-S04B22TB	.468(11.88)	.624(15.84)
5	FWF39604-S05B22TB	.624(15.84)	.780(19.80)
6	FWF39604-S06B22TB	.780(19.80)	.935(23.76)
7	FWF39604-S07B22TB	.935(23.76)	1.091(27.72)
8	FWF39604-S08B22TB	1.091(27.72)	1.247(31.68)
9	FWF39604-S09B22TB	1.247(31.68)	1.403(35.64)
10	FWF39604-S10B22TB	1.403(35.64)	1.559(39.60)
11	FWF39604-S11B22TB	1.559(39.60)	1.715(43.56)
12	FWF39604-S12B22TB	1.715(43.56)	1.871(47.52)

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 19/SEP/15	PART NO. FWF39604-SXXB22TB	ITEM NO. FWF39604	 Leader Of Industry	
	X.±.012(0.30)	X.'±5'	CHECKED BY CHERRY	DATE 19/SEP/15	TITLE Wire to Board (Wafer) Pitch 3.96mm 90° Angle (DIP)			REV 1
	DESIGN UNITS Inch (metric)	X.X±.008(0.20)	.X'±2'	DRAWN BY JACOB	DATE 19/SEP/15	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
	SCALE 5:1	SIZE A4	X.XX±.006(0.15)	X.X'±1'	X.XXX±.004(0.10)	X.XX'±0.5'		

1 2 3 4 5 6 7 8